

# INT

## Integration ready Atomflo™ system

The INT series Atomflo™ plasma system is configured to integrate into your new or existing process equipment. Communicate over Ethernet IP for complete process control and data logging. The INT provides the most advanced surface treatment technology inside your equipment.

Select from a variety of plasma head sizes from small 2-mm spot to 100-mm-wide linear beam.



Atomflo™ Rack Mounted

The INT series plasma system can be integrated in line, or in a batch tool. Features include:

- Real-time monitoring and control of process conditions.
- Standard 19 inch server rack modules for easy integration
- Easily pass industry compliance with INT series modules

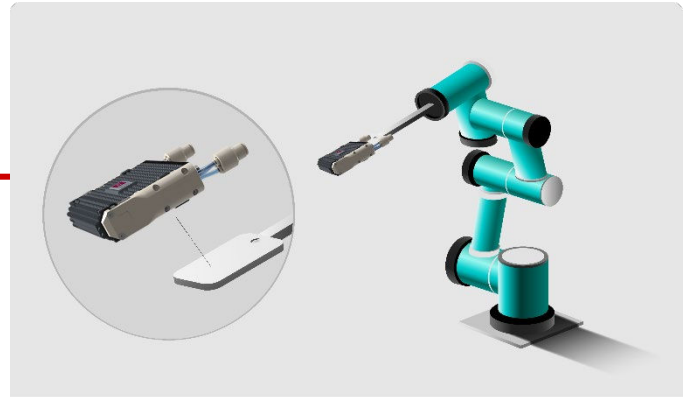
For more information, contact Surfx at:

[sales@surfxtechnologies.com](mailto:sales@surfxtechnologies.com)

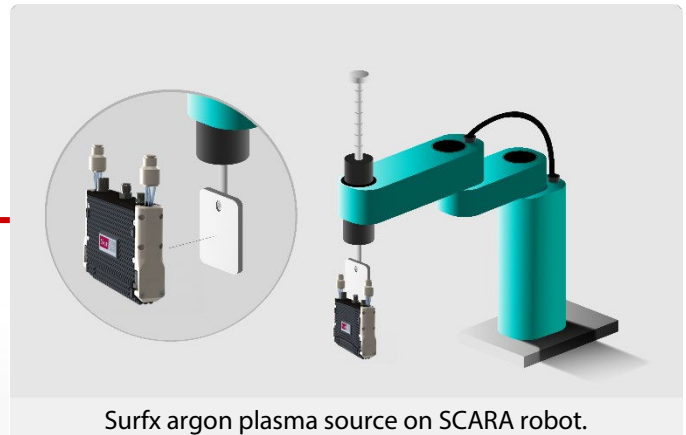
or +1 310 558 0770



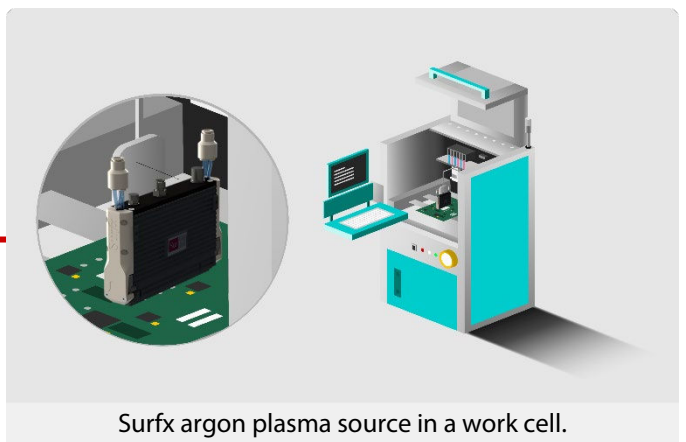
The most trusted name in atmospheric plasma.™



Surfx argon plasma source on six-axis robot.



Surfx argon plasma source on SCARA robot.



Surfx argon plasma source in a work cell.

[www.surfxtechnologies.com](http://www.surfxtechnologies.com)

### North America

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The INT series Atomflo™ plasma system is designed to integrate automated surface treatment into a customer's process equipment or manufacturing line.

## Gas Tray Facilities

Plasma gases* (choose one)				
Type	Inlet Fitting**	Regulator	Max Flow (LPM)	Operating Pressure
Argon (Ar)	3/8-inch OD	CGA 580	40	0.35-0.7 MPa (50-100 psig)
Helium (He)	3/8-inch OD	CGA 580	60	0.35-0.7 MPa (50-100 psig)
Process gases* (choose two)				
Type	Inlet Fitting**	Regulator	Max Flow (LPM)	Supply Gas Pressure
Oxygen (O <sub>2</sub> )	1/4-inch OD	CGA 540	0.60	0.35-0.7 MPa (50-100 psig)
Nitrogen (N <sub>2</sub> )	1/4-inch OD	CGA 580	0.60	0.35-0.7 MPa (50-100 psig)
5.0% H <sub>2</sub> in argon	1/4-inch OD	CGA 580	10.0	0.35-0.7 MPa (50-100 psig)

\*Gas purity should be at least 99.99% (industrial grade).

\*\*Swagelok bulkhead connector.

## Controller Facilities

Specifications	
Power supply	200 – 240 VAC, 8 A, 50/60 Hz
Air supply (CDA)	None
Dimensions (W*D*H)	19 inch server rack compatible Added dimensions see module detail sheet
Weight	23 kg (51 lbs)

## Coolant Control Module Facilities

Specifications	
Coolant	Distilled or deionized water (1.0 Liter)
Power supply	200 – 240 VAC, 4.1 A, 50/60 Hz
Air supply (CDA)	None
Dimensions (W*D*H)	19 inch server rack compatible Added dimensions see module detail sheet
Weight (dry)	9 kg (20 lbs)

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